

Electronic Patent Application Fee Transmittal

Application Number:				
Filing Date:				
Title of Invention:	Mold, Method of Forming the Same, and Method of Producing Polycrystalline Silicon Substrate Using the Mold			
First Named Inventor:	Youhei Sakai			
Filer:	Lawrence James McClure/Gary Chernyavsky			
Attorney Docket Number:	81872.0124			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
National Stage Fee	1631	1	300	300
Natl Stage Search Fee - Report provided	1642	1	400	400
National Stage Exam - all other cases	1633	1	200	200
Pages:				
Claims:				
Claims in excess of 20	1615	15	50	750
Multiple dependent claims	1616	1	360	360
Miscellaneous-Filing:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Miscellaneous:				
			Total in USD (\$)	2010